

Title (en)

CONDUCTIVE PROPYLENE RESIN COMPOSITION AND PARTS CONTAINER

Title (de)

LEITFÄHIGE PROPYLENHARZZUSAMMENSETZUNG UND BEHÄLTER FÜR TEILE

Title (fr)

COMPOSITION DE RESINE DE PROPYLENE CONDUCTRICE ET CONTENEUR A PIECES

Publication

**EP 0899298 B1 20020213 (EN)**

Application

**EP 97920947 A 19970512**

Priority

- JP 9701580 W 19970512
- JP 11787696 A 19960513

Abstract (en)

[origin: EP0899298A1] A conductive propylene resin composition, which is used for packaging and automatic feeding of parts which is unlikely be electrically charged, which is resistive to a baking treatment and which does not produce wastes and can reduce a material cost and a processing cost, is provided. The composition contains of (1) a % by weight of a propylene polymer with a portion having not less than 95 % by weight of crystallinity that occupies not less than 60 % by weight of the propylene polymer, and contains not more than 20 % by weight of ethylene; (2) b % by weight of a propylene random copolymer which has a tensile elongation of not less than 100 % and contains 1 to 7 % by weight of ethylene; and (3) c % by weight of an electrically conductive filler, wherein the following relationships are satisfied:  $a + b + c = 100$ ,  $0.5 \leq a / b \leq 2.0$  and  $10 \leq c \leq 30$ .

IPC 1-7

**C08L 23/00**; **C08K 3/00**

IPC 8 full level

**B65D 73/02** (2006.01); **C08L 23/10** (2006.01); **C08L 23/12** (2006.01); **C08L 23/14** (2006.01); **C08L 23/08** (2006.01); **C08L 23/16** (2006.01)

CPC (source: EP KR)

**B65D 73/02** (2013.01 - KR); **C08L 23/10** (2013.01 - EP); **C08L 23/12** (2013.01 - EP); **C08L 23/14** (2013.01 - EP KR); **C08L 23/142** (2013.01 - EP); **C08L 23/0815** (2013.01 - EP); **C08L 23/16** (2013.01 - EP); **C08L 2205/02** (2013.01 - EP); **C08L 2205/03** (2013.01 - EP)

Citation (examination)

US 4522994 A 19850611 - CHIBA HIROMASA [JP], et al

Cited by

US7390563B2; WO0236667A1

Designated contracting state (EPC)

DE GB

DOCDB simple family (publication)

**EP 0899298 A1 19990303**; **EP 0899298 A4 19991215**; **EP 0899298 B1 20020213**; CN 1126785 C 20031105; CN 1226270 A 19990818; DE 69710452 D1 20020321; DE 69710452 T2 20021010; KR 100291762 B1 20010917; KR 20000010912 A 20000225; WO 9743338 A1 19971120

DOCDB simple family (application)

**EP 97920947 A 19970512**; CN 97194538 A 19970512; DE 69710452 T 19970512; JP 9701580 W 19970512; KR 19980709059 A 19981110